

IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL

ABM11W SERIES



2.0 x 1.6 x 0.5mm



RoHS/RoHS II Compliant

MSL = N/A: NOT APPLICABLE

FEATURES

- Optimized for energy saving wearables, and IoT applications
- Plated at exceptionally low plating capacitance, as low as 4pF, with optimized ESR
- 0.5 mm max height ideally suited for height constrained designs
- Seam sealed for longterm reliability

APPLICATIONS

- Wearables
- Internet of Things (IoT)
- Bluetooth/Bluetooth Low Energy (BLE)
- Wireless modules
- Machine-to-machine (M2M) connectivity
- Ultra-low power MCU
- Near Field Communication (NFC)
- ISM Band

STANDARD SPECIFICATIONS

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency Range	16.0000		50.0000	MHz	
Operation Mode	Fundamental				
Operating Temperature Range	-40		+125	°C	See options
Storage Temperature	-55		+125	°C	
Frequency Tolerance @ +25°C	-10		+10	ppm	See options
Frequency Stability over the Operating Temperature (ref. to +25°C)	-10		+10	ppm	See options
Equivalent series resistance (R1)			200	Ω	16.0000 – 17.9999MHz
			120		18.0000 – 23.9999MHz
			100		24.0000 – 29.9999MHz
			80		30.0000 – 37.9999MHz
			60		38.0000 – 50.0000MHz
Shunt capacitance (C0)		< 1.0	2.0	pF	
Load capacitance (CL)		4.0		pF	See options
Drive Level		10	100	μW	
Aging (1 year)	-2		+2	ppm	@ 25°C±3°C
Insulation Resistance	500			MΩ	@ 100Vdc ± 15V

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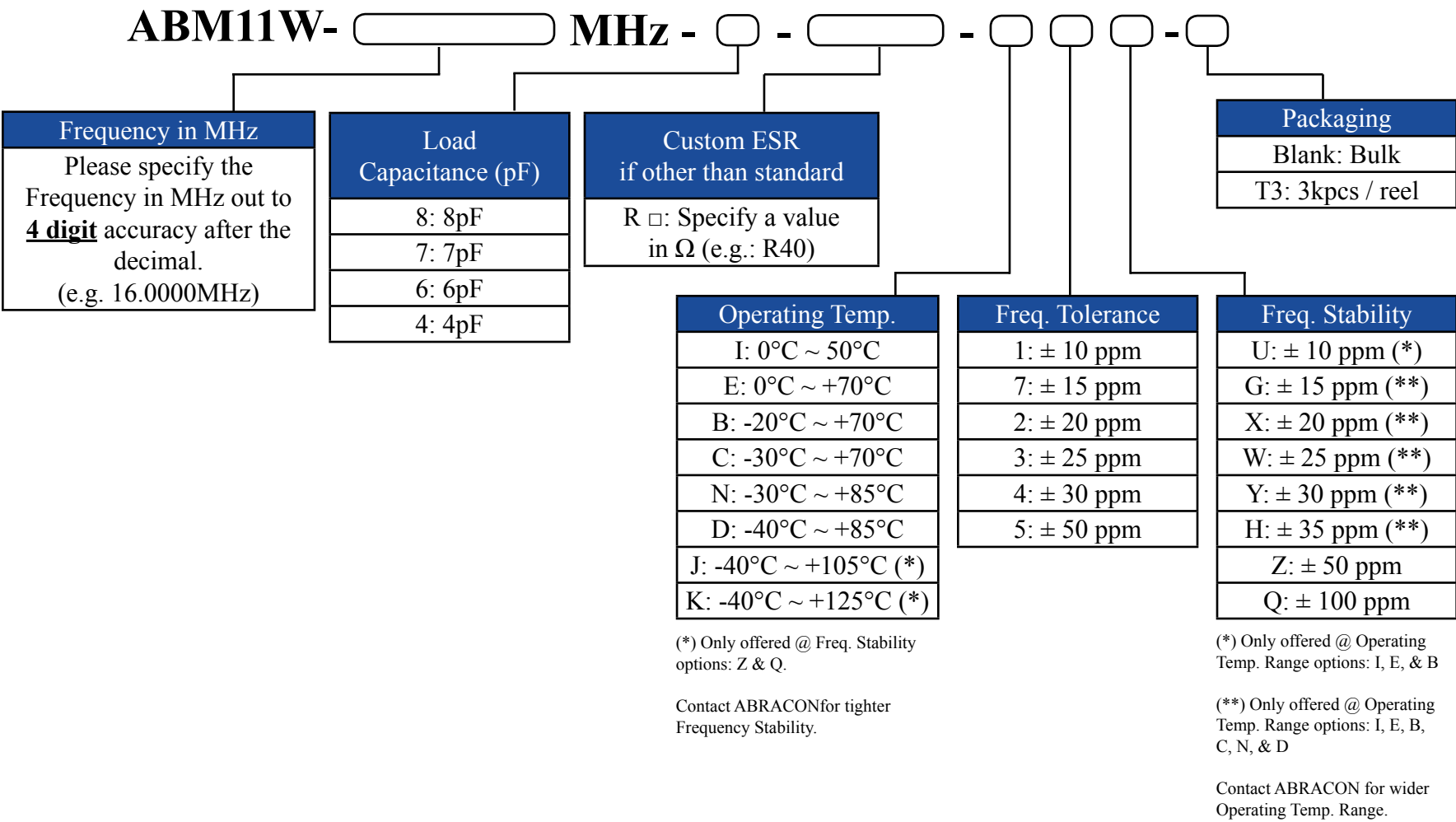


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OPTIONS AND PART IDENTIFICATION (NOTE 1)

Note 1: Contact Abracon for part number requests with carrier frequency callouts up to 5 & 6 digit accuracy after the decimal.



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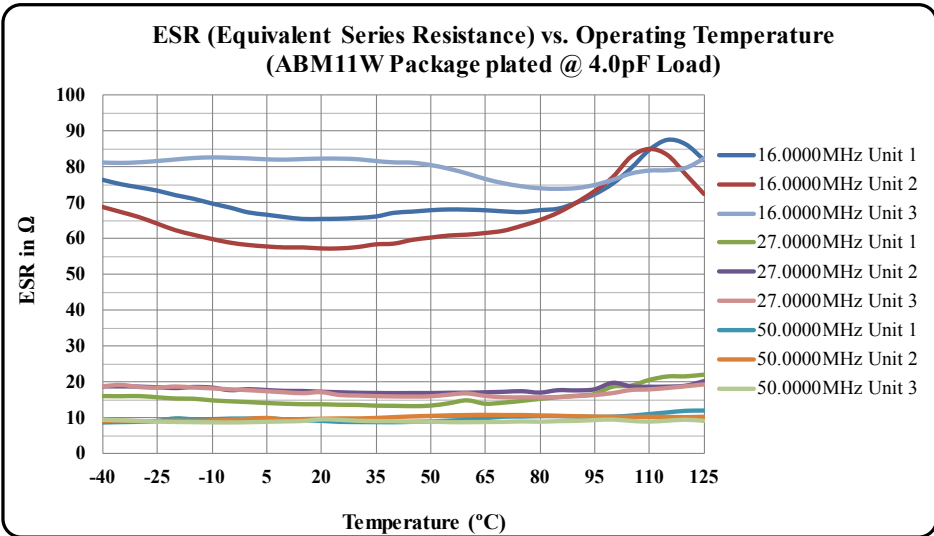
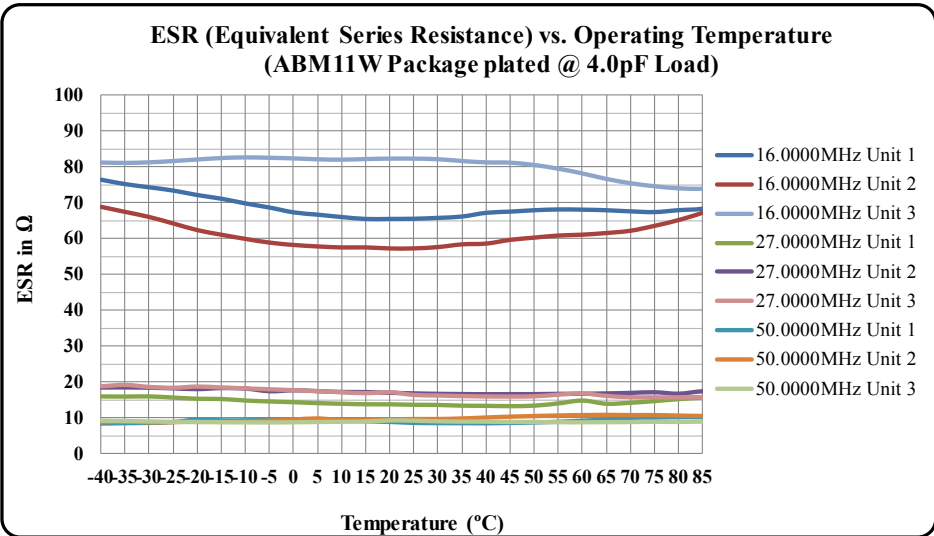
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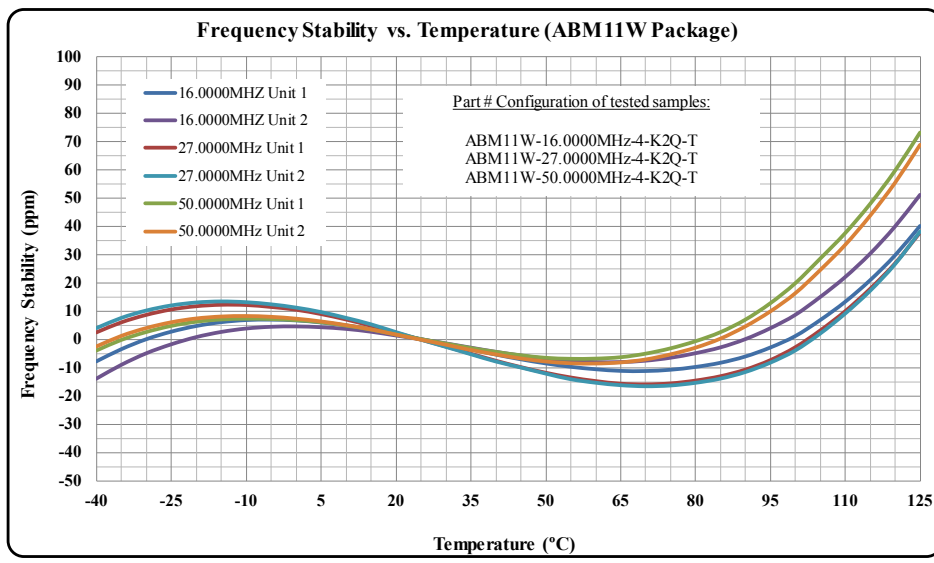
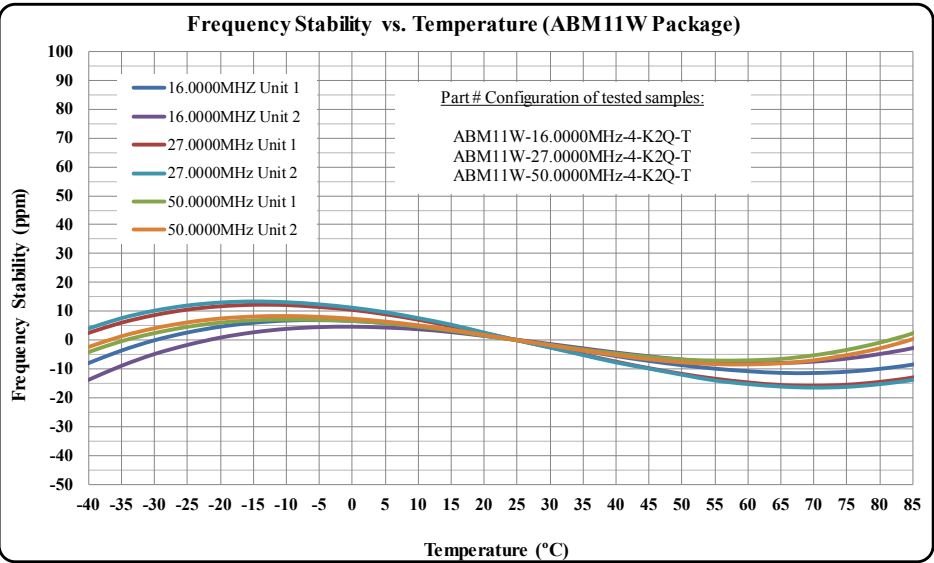
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TYPICAL ESR (EQUIVALENT SERIES RESISTANCE) Vs. TEMPERATURE CHARACTERISTICS



TYPICAL FREQUENCY Vs. TEMPERATURE CHARACTERISTICS



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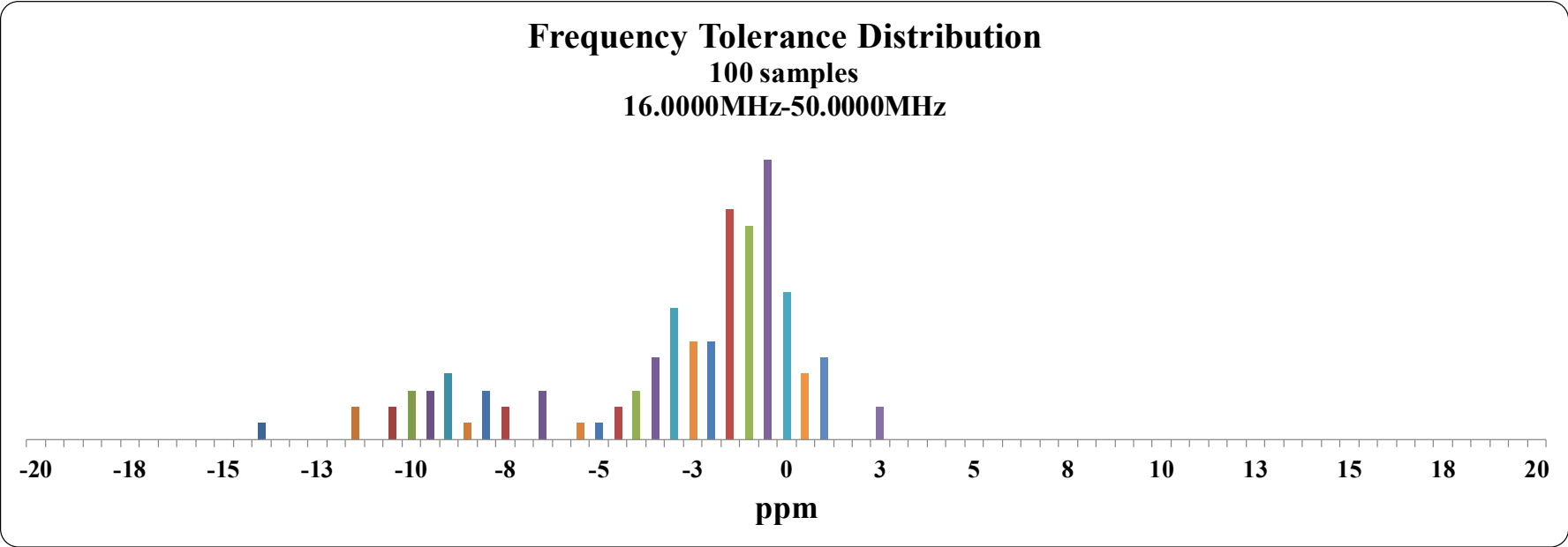
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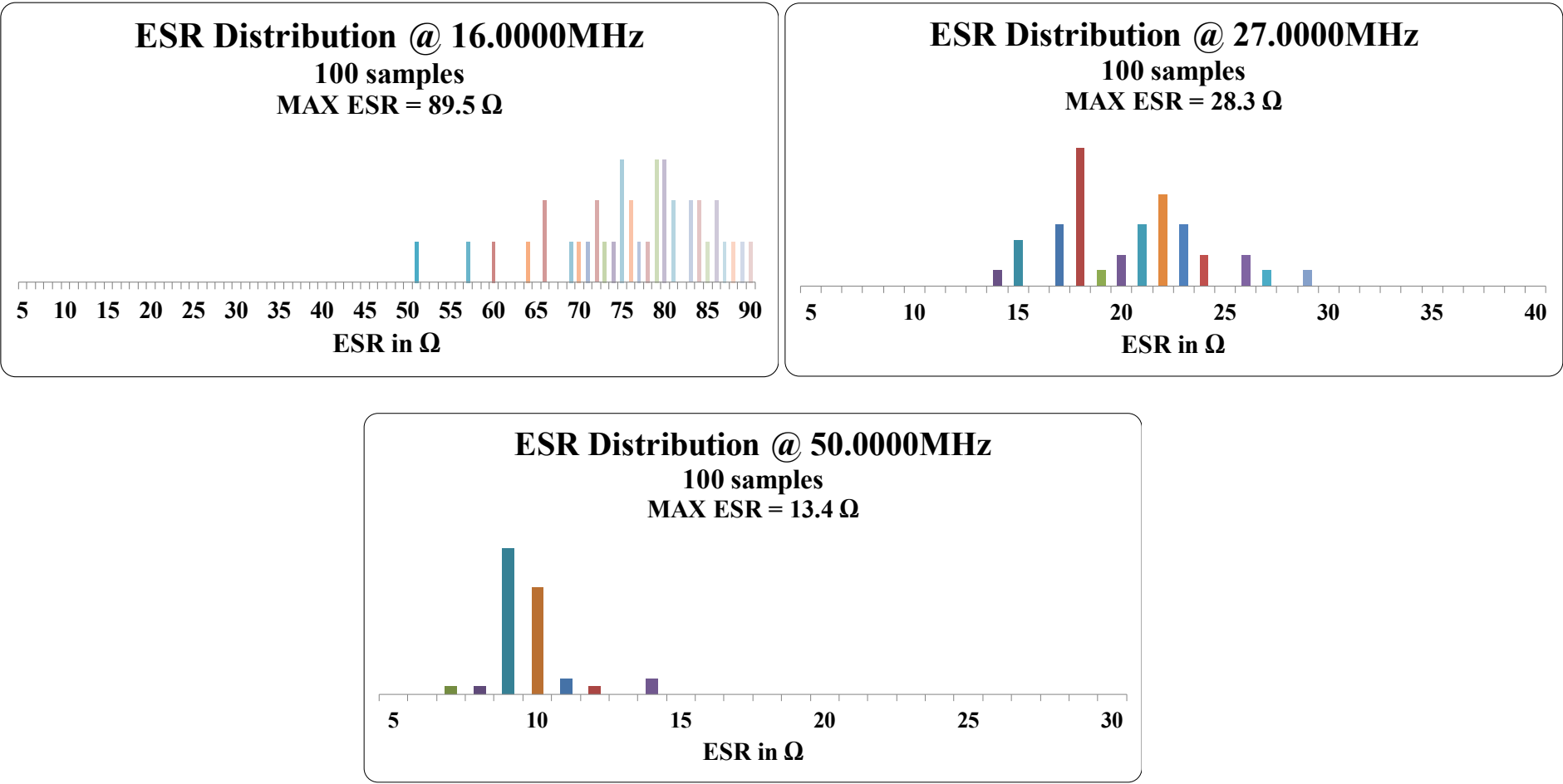
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TYPICAL FREQUENCY TOLERANCE DISTRIBUTION (AT 25°C ± 3°C)



TYPICAL ESR DISTRIBUTION (AT 25°C ± 3°C)



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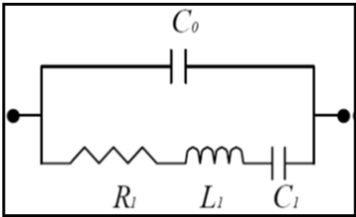
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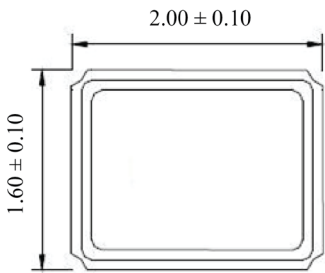
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SPICE MODELS (BASED ON TYPICAL VALUES AT 25°C ± 3°C)

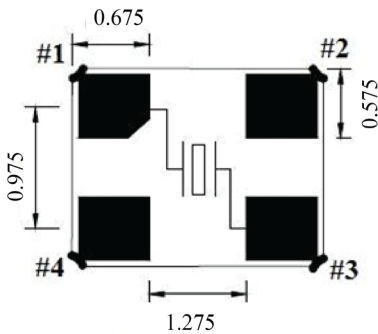
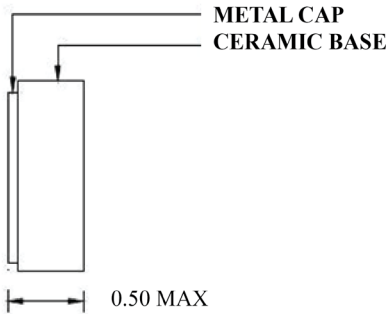


Frequency: 16.0000MHz Plating Load: 4pF				Frequency: 16.0000MHz Plating Load: 6pF			
C0	=	0.73	pF	C0	=	0.71	pF
R1	=	73.02	Ω	R1	=	81.42	Ω
L1	=	84.25	mH	L1	=	81.33	mH
C1	=	1.18	fF	C1	=	1.22	fF
Frequency: 27.0000MHz Plating Load: 4pF				Frequency: 27.0000MHz Plating Load: 6pF			
C0	=	0.78	pF	C0	=	0.76	pF
R1	=	18.71	Ω	R1	=	20.45	Ω
L1	=	18.08	mH	L1	=	18.44	mH
C1	=	1.92	fF	C1	=	1.89	fF
Frequency: 50.0000MHz Plating Load: 4pF				Frequency: 50.0000MHz Plating Load: 6pF			
C0	=	0.92	pF	C0	=	0.97	pF
R1	=	9.02	Ω	R1	=	8.49	Ω
L1	=	3.53	mH	L1	=	3.21	mH
C1	=	2.88	fF	C1	=	3.15	fF

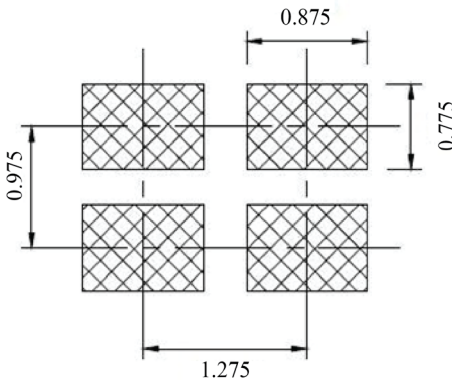
MECHANICAL DIMENSIONS



TOP VIEW



BOTTOM VIEW
Pin #2: GND
Pin #4: GND



RECOMMENDED LANDING PATTERN
DIMENSIONS: mm

Note:

Due to material availability the Chamfer could be located on pin #1, 2 or 4. Be advised that the Chamfer location has no impact on the electrical performance of the device.

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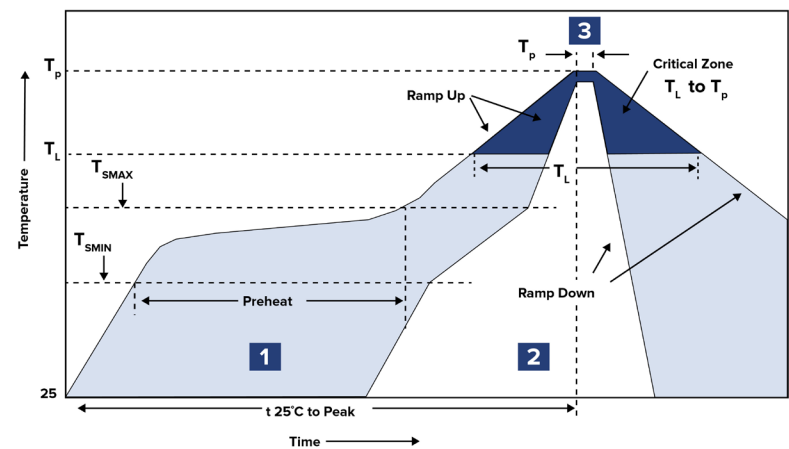
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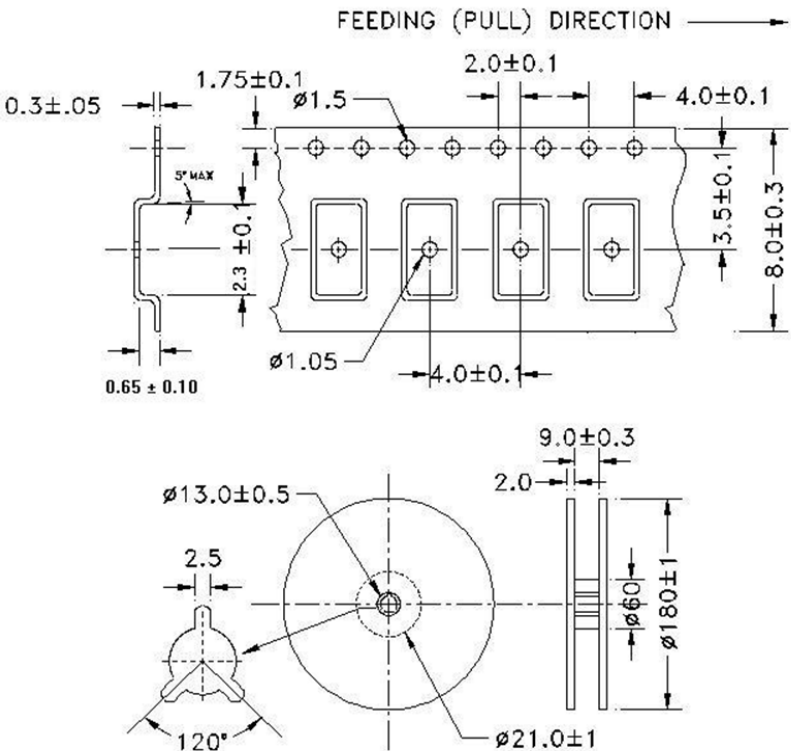
REFLOW PROFILE



Zone	Description	Temperature	Time
1	Preheat	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 180°C	60 ~ 120 sec.
2	Reflow	T_L 217°C	45 ~ 90 sec.
3	Peak Heat	T_P 260°C MAX	10 sec.

PACKAGING

T3: Tape and reel (3,000 pcs/reel)



DIMENSIONS: mm